

06-25-2010

U.S. PTO  
12/802679  
06/11/2010



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6-11-10  
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Sir:

**RECORDATION FORM COVER SHEET**  
**PATENTS ONLY**

Enclosed for recordation in the records of the U.S. Patent and Trademark Office is  
AN ORIGINAL document with particulars as follows:

- (1) Name of conveying party:

Russell A. Monk  
Lance A. Hicks

12802679

- (2) Name and address of receiving party:

High Impact Technology, L.L.C.  
9900 S.W. Tigard Street  
Tigard, Oregon 97223

- (3) The nature of the conveyance is AN ASSIGNMENT, which was executed  
on May 28, 2010 and June 1, 2010.

- (4) This document is being filed with a new patent application, for which the  
execution date of the application is May 28, 2010 and June 1, 2010.

- (5) Any and all correspondence concerning this document should be addressed  
and mailed to the following:

Robert D. Varitz, Esq.  
Customer No. 56703

- (6) The total number of patent applications involved in this conveyance is -1-.

- (7) A PTO Form 2038 credit card authorization including the amount of  
\$40.00 to cover the recordation fee is enclosed, in accordance with  
37 C.F.R. § 3.41.

Page 1 RECORDATION COVER SHEET; Application of Russell A. Monk *et al.*; Attorney  
Docket No. J-HITT.1037B

PATENT

REEL: 024594 FRAME: 0105

6/15/2010 HDETA1 00000019 12802679

40.00 DP

4 FC:8021

## ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned,

Russell A. Monk  
Lance A. Hicks

1. Hereby sell, assign and transfer to High Impact Technology, L.L.C., having a place of business at 9900 S.W. Tigard Street; Tigard, Oregon 97223, its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries: (a) in and to any and all inventions which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is:

**Entitled:** - Layered Panel Structure Including Self-Bonded Layers of Thermoformable and Non-Thermoformable Materials  
**Docket Number:** - J-HITT.1037B

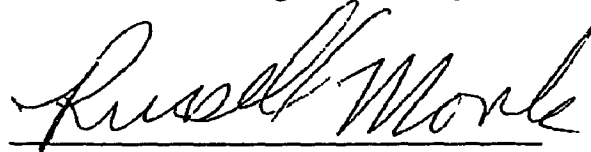
(b) in and to the application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said inventions; and (c) in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said inventions;

2. Agree that the Assignee may apply for and receive Letters Patent for said inventions in its own name; and that, when requested, (at the expense of the Assignee, its successors, assigns and legal representatives), the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to the Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said inventions and the history thereof; and generally to do everything reasonable which the Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and for vesting title to said inventions and all applications for patents and all patents on said inventions, in the Assignee, its successors, assigns and legal representatives; and

3. Covenant with the Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

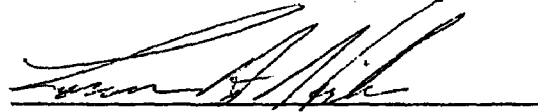
Date 5-28-2010

Signature:

  
Russell A. Monk

Date 06-01-2010

Signature:

  
Lance A. Hicks